Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	32
Program Memory Size	8KB (8K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 32x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f206r

List of Figures and Tables

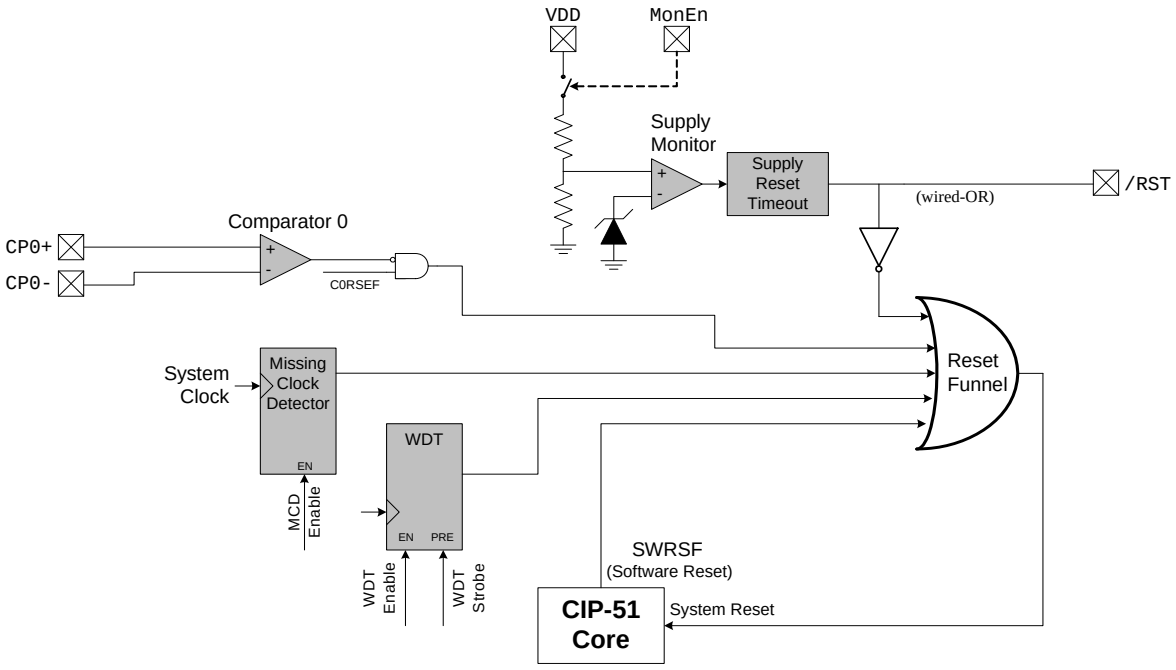


Figure 1.6. Comparison of Peak MCU Throughputs

1.2. On-Board Memory

The CIP-51 has a standard 8051 program and data address configuration. It includes 256 bytes of data RAM, with the upper 128 bytes dual-mapped. An optional 1024 bytes of XRAM is available on the 'F206, 'F226 and 'F236. Indirect addressing accesses the upper 128 bytes of general purpose RAM, and direct addressing accesses the 128-byte SFR address space. The lower 128 bytes of RAM are accessible via direct or indirect addressing. The first 32 bytes are addressable as four banks of general purpose registers, and the next 16 bytes can be byte addressable or bit addressable.

The MCU's program memory consists of 8 k + 128 bytes of Flash. This memory may be reprogrammed in-system in 512 byte sectors, and requires no special off-chip programming voltage. The 512 bytes from addresses 0x1E00 to 0x1FFF are reserved for factory use. There is also a user programmable 128-byte sector at address 0x2000 to 0x207F, which may be useful as a table for storing software constants, nonvolatile configuration information, or as additional program space. See Figure 1.7 for the MCU system memory map.

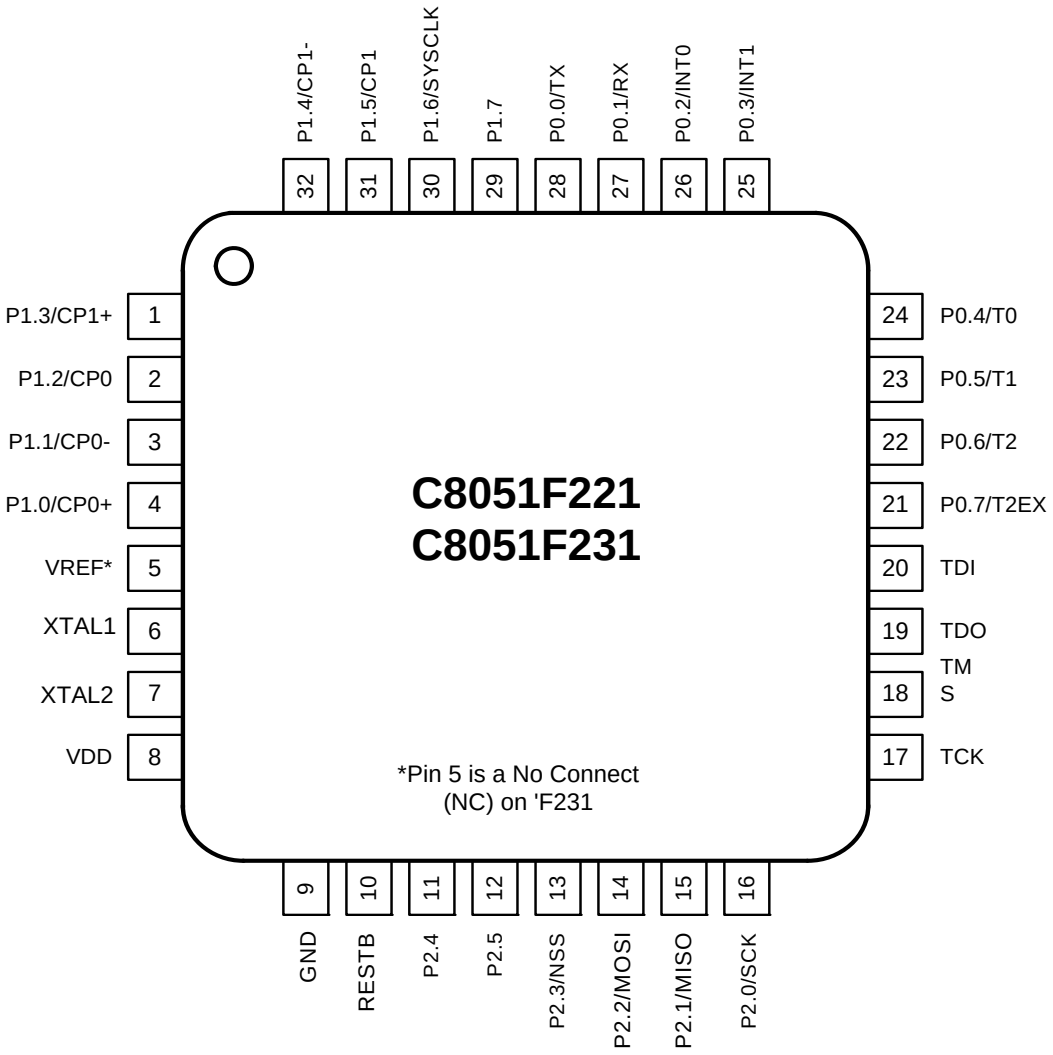


Figure 4.2. LQFP-32 Pin Diagram

SFR Definition 5.3. ADC0CN: ADC Control (C8051F220/1/6 and C8051F206)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ADCEN	ADCTM	ADCINT	ADBUSY	ADSTM1	ADSTM0	ADWINT	ADLJST	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xE8

Bit7: ADCEN: ADC Enable Bit
0: ADC Disabled. ADC is in low power shutdown.
1: ADC Enabled. ADC is active and ready for data conversions.

Bit6: ADCTM: ADC Track Mode Bit
0: When the ADC is enabled, tracking is continuous unless a conversion is in process
1: Tracking Defined by ADSTM1-0 bits
ADSTM1-0:
00: Tracking starts with the write of 1 to ADBUSY and lasts for 3 SAR clocks
01: RESERVED
10: RESERVED
11: Tracking started by the overflow of Timer 2 and last for 3 SAR clocks

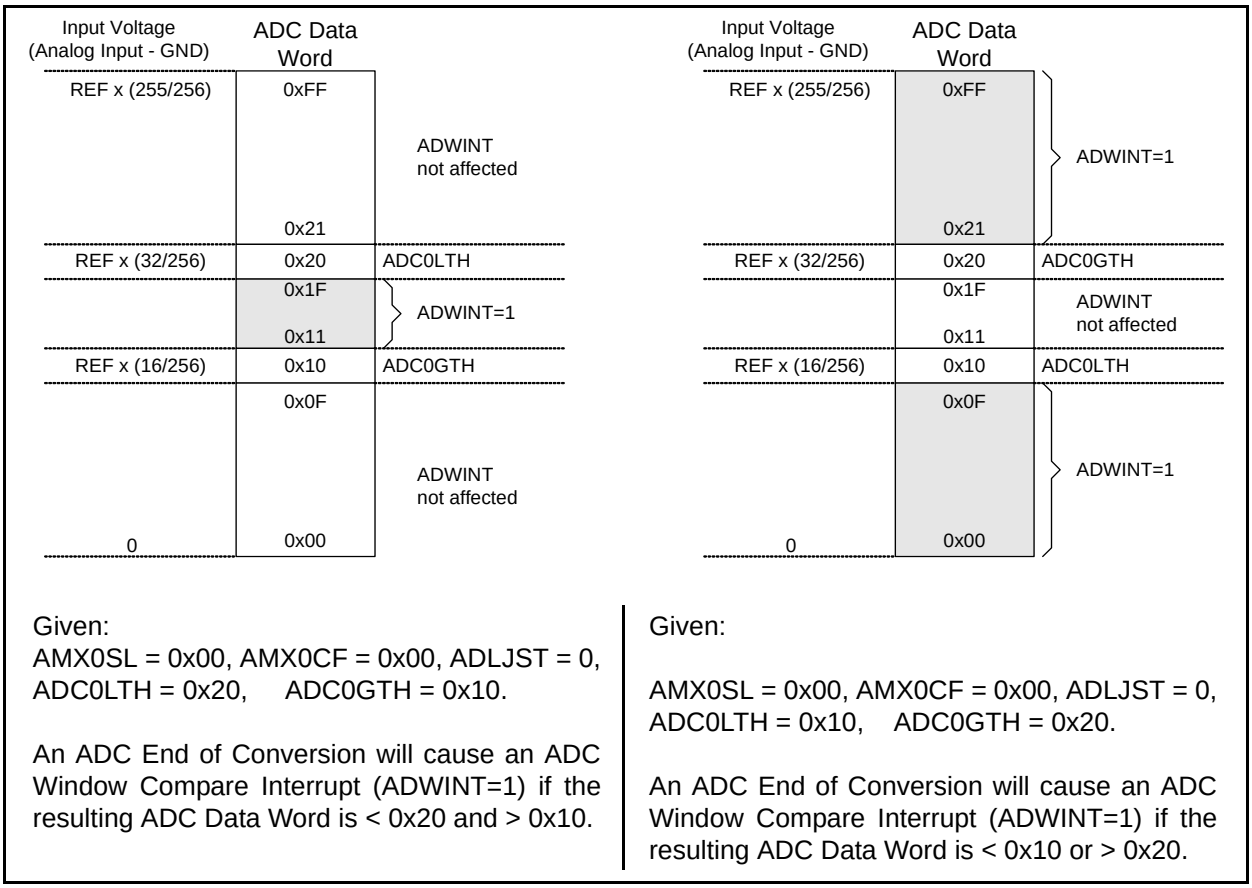
Bit5: ADCINT: ADC Conversion Complete Interrupt Flag (cleared by software).
0: ADC has not completed a data conversion since the last time this flag was cleared
1: ADC has completed a data conversion

Bit4: ADBUSY: ADC Busy Bit
Read
0: ADC Conversion complete or no valid data has been converted since a reset. The falling edge of ADBUSY generates an interrupt when enabled.
1: ADC Busy converting data
Write
0: No effect
1: Starts ADC Conversion if ADSTM1-0 = 00b

Bits3–2: ADSTM1–0: ADC Start of Conversion Mode Bits
00: ADC conversion started upon a write of 1 to ADBUSY
01: RESERVED
10: RESERVED
11: ADC conversions initiated on overflows of Timer 2

Bit1: ADWINT: ADC Window Compare Interrupt Flag
0: ADC Window Comparison Data match has not occurred
1: ADC Window Comparison Data match occurred

Bit0: ADLJST: ADC Left Justify Data Bit (Used on C8051F206 only)
0: Data in ADC0H:ADC0L registers are right justified.
1: Data in ADC0H:ADC0L registers are left justified.



Given:
AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
ADC0LTH = 0x20, ADC0GTH = 0x10.

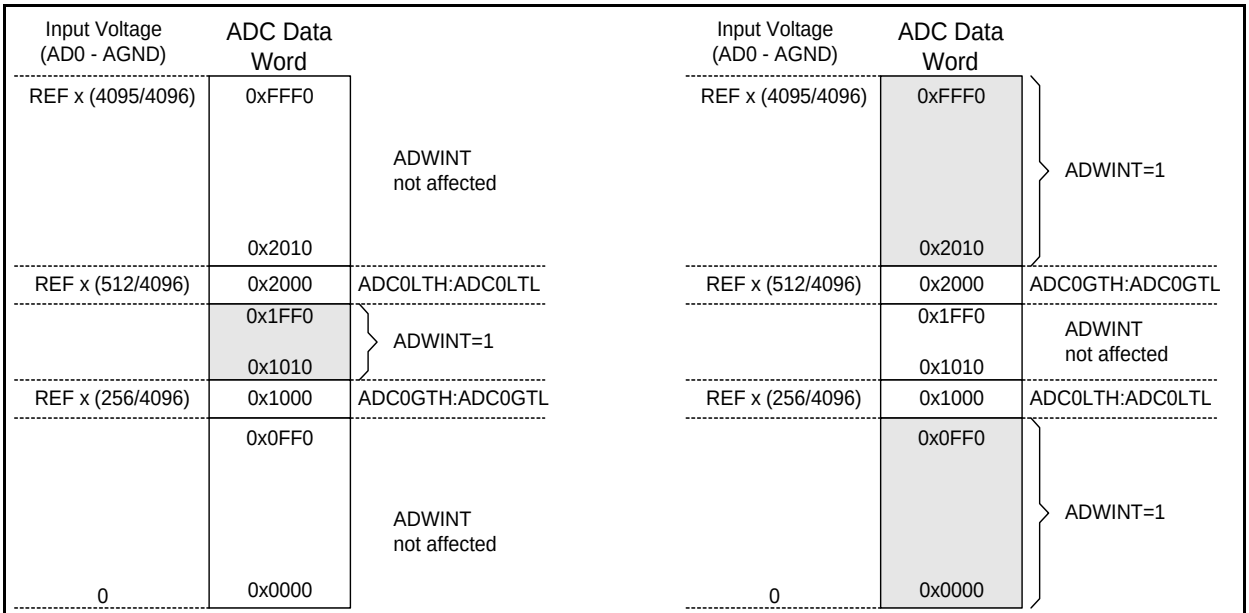
An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x20 and > 0x10.

Given:

AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
ADC0LTH = 0x10, ADC0GTH = 0x20.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x10 or > 0x20.

Figure 5.3. 8-Bit ADC Window Interrupt Examples



Given:

AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 1, ADC0LTH:ADC0LTL = 0x2000, ADC0GTH:ADC0GTL = 0x1000.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x2000 and > 0x1000.

Given:

AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 1, ADC0LTH:ADC0LTL = 0x1000, ADC0GTH:ADC0GTL = 0x2000.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x1000 or > 0x2000.

Figure 6.4. 12-Bit ADC Window Interrupt Examples, Left Justified Data

Table 6.1. 12-Bit ADC Electrical Characteristics (C8015F206 only)

V_{DD} = 3.0 V, VREF = 2.40 V (REFBE=0), PGA Gain = 1, –40 to +85 °C unless otherwise specified.

Parameter	Conditions	Min	Typ	Max	Units
DC Accuracy					
Resolution			12		bits
Integral Nonlinearity		—	±1	±2	LSB
Differential Nonlinearity	Guaranteed Monotonic	—	—	±2	LSB
Offset Error		±20	±5	—	LSB
Full Scale Error	Differential mode	—	—	–20±10	LSB
Offset Temperature Coefficient		—	±0.25	—	ppm/°C
Dynamic Performance (10 kHz sine-wave input, 0 to –1 dB of full scale, 100 ksps)					
Signal-to-Noise Plus Distortion		63	66	—	dB
Total Harmonic Distortion	Up to the 5th harmonic	–60	–72	—	dB
Spurious-Free Dynamic Range		60	76	—	dB
Conversion Rate					
Conversion Time in SAR Clocks		16	—	—	clocks
SAR Clock Frequency		—	—	2.0	MHz
Track/Hold Acquisition Time		1.5	—	—	µs
Throughput Rate		—	—	100	ksps
Analog Inputs					
Voltage Conversion Range		0	—	VREF	V
Input Voltage	Any pin (in Analog Input Mode)	GND	—	V_{DD}	V
Input Capacitance		—	10	—	pF
Power Specifications					
Power Supply Current (V_{DD} supplied to ADC)	Operating Mode, 100 ksps	—	0.45	1.0	mA
Power Supply Rejection		—	±0.3	—	mV/V

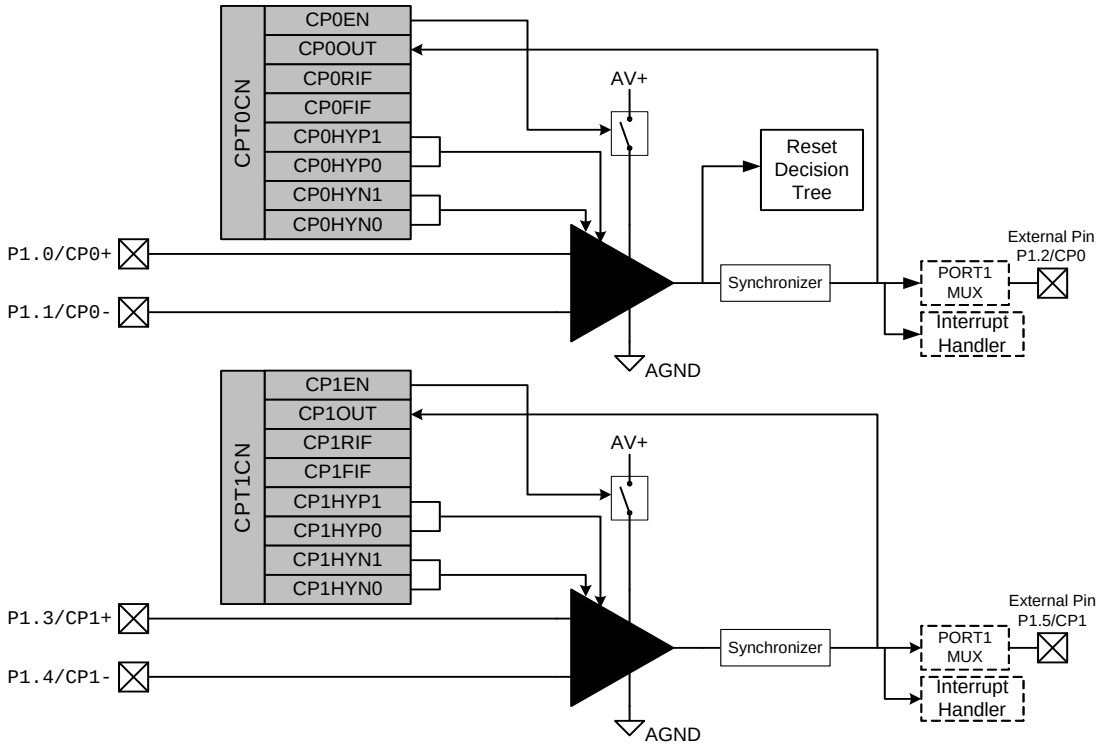


Figure 8.1. Comparator Functional Block Diagram

Table 9.3. Special Function Registers

SFR's are listed in alphabetical order.

Address	Register	Description	Page No.
0xE0	ACC	Accumulator	73
0xBC	ADC0CF	ADC Configuration	35
0xE8	ADC0CN	ADC Control	36
0xC5	ADC0GTH[1]	ADC Greater-Than Data Word (High Byte)	37
0xC4	ADC0GTL[4]	ADC Greater-Than Data Word (Low Byte)	46
0xBF	ADC0H[1]	ADC Data Word (High Byte)	37
0xBE	ADC0L[4]	ADC Data Word (Low Byte)	45
0xC7	ADC0LTH[1]	ADC Less-Than Data Word (High Byte)	46
0xCE	ADC0LTL[4]	ADC Less-Than Data Word (Low Byte)	47
0xBB	AMX0SL	ADC MUX Channel Selection	34
0xF0	B	B Register	73
0x8E	CKCON	Clock Control	131
0x9E	CPT0CN	Comparator 0 Control	55
0x9F	CPT1CN	Comparator 1 Control	56
0x83	DPH	Data Pointer (High Byte)	71
0x82	DPL	Data Pointer (Low Byte)	71
0xE6	EIE1	Extended Interrupt Enable 1	79
0xE7	EIE2	Extended Interrupt Enable 2	80
0xF6	EIP1	External Interrupt Priority 1	81
0xF7	EIP2	External Interrupt Priority 2	82
0xAF	EMI0CN[3]	External Memory Interface Control	90
0xB7	FLACL	Flash Memory Read Limit	89
0xB6	FLSCL	Flash Memory Timing Prescaler	89
0xA8	IE	Interrupt Enable	77
0xB8	IP	Interrupt Priority Control	78
0xB2	OSCICN	Internal Oscillator Control	98
0xB1	OSCXCN	External Oscillator Control	99
0x80	P0	Port 0 Latch	105
0x90	P1	Port 1 Latch	106
0xA0	P2	Port 2 Latch	107
0xB0	P3	Port 3 Latch	108
0xF1	P0MODE	Port0 Digital/Analog Output Mode	106
0xF2	P1MODE	Port1 Digital/Analog Output Mode	107
0xF3	P2MODE	Port2 Digital/Analog Output Mode	108
0xF4	P3MODE[2]	Port3 Digital/Analog Output Mode	109
0x87	PCON	Power Control	84

The Flash Access Limit security feature protects proprietary program code and data from being read by software running on the CIP-51. This feature provides support for OEMs that wish to program the MCU with proprietary value-added firmware before distribution. The value-added firmware can be protected while allowing additional code to be programmed in remaining program memory space later.

The Software Read Limit (SRL) is a 16-bit address that establishes two logical partitions in the program memory space. The first is an upper partition consisting of all the program memory locations at or above the SRL address, and the second is a lower partition consisting of all the program memory locations starting at 0x0000 up to (but excluding) the SRL address. Software in the upper partition can execute code in the lower partition, but is prohibited from reading locations in the lower partition using the MOVC instruction. (Executing a MOVC instruction from the upper partition with a source address in the lower partition will always return a data value of 0x00.) Software running in the lower partition can access locations in both the upper and lower partition without restriction.

The Value-added firmware should be placed in the lower partition. On reset, control is passed to the value-added firmware via the reset vector. Once the value-added firmware completes its initial execution, it branches to a predetermined location in the upper partition. If entry points are published, software running in the upper partition may execute program code in the lower partition, but it cannot read the contents of the lower partition. Parameters may be passed to the program code running in the lower partition either through the typical method of placing them on the stack or in registers before the call or by placing them in prescribed memory locations in the upper partition.

The SRL address is specified using the contents of the Flash Access Register. The 16-bit SRL address is calculated as 0xNN00, where NN is the contents of the SRL Security Register. Thus, the SRL can be located on 256-byte boundaries anywhere in program memory space. However, the 512-byte erase sector size essentially requires that a 512 boundary be used. The contents of a non-initialized SRL security byte is 0x00, thereby setting the SRL address to 0x0000 and allowing read access to all locations in program memory space by default.

SFR Definition 10.1. PSCTL: Program Store RW Control

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	-	-	PSEE	PSWE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0x8F

Bits7–2: UNUSED. Read = 000000b, Write = don't care.

Bit1: PSEE: Program Store Erase Enable.
Setting this bit allows an entire page of the Flash program memory to be erased (provided the PSWE bit is set to '1'). After setting this bit, a write to Flash memory using the MOVX instruction will erase the entire page that contains the location addressed by the MOVX instruction. The value of the data byte written does not matter.
0: Flash program memory erasure disabled.
1: Flash program memory erasure enabled.

Bit0: PSWE: Program Store Write Enable.
Setting this bit allows writing a byte of data to the Flash program memory using the MOVX instruction. The location must be erased before writing data.
0: Write to Flash program memory disabled.
1: Write to Flash program memory enabled.

SFR Definition 14.1. PRT0MX: Port I/O MUX Register 0

R/W	R/W	R/W	R/W	R/W	R/W	R	R/W	Reset Value
T2EXE	T2E	T1E	T0E	INT1E	INT0E	-	UARTEN	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xE1

Bit7: T2EXE: T2EX Enable Bit
0: T2EX unavailable at Port pin.
1: T2EX routed to Port Pin.

Bit6: T2E: T2 Enable Bit
0: T2 unavailable at Port pin.
1: T2 routed to Port Pin.

Bit5: T1E: T1 Enable Bit
0: T1 unavailable at Port pin.
1: T1 routed to Port Pin.

Bit4: T0E: T0 Enable Bit
0: T0 unavailable at Port pin.
1: T0 routed to Port Pin.

Bit3: INT1E: /INT1 Enable Bit
0: /INT1 unavailable at Port pin.
1: /INT1 routed to port pin.

Bit2: INT0E: /INT0 Enable Bit
0: /INT0 unavailable at Port pin.
1: /INT0 routed to Port Pin.

Bit1: UNUSED. Read = 0, Write = don't care.

Bit0: UARTEN: UART I/O Enable
0: UART I/O unavailable at port pins.
1: TX, RX routed to pins P0.0 and P0.1, respectively.

SFR Definition 14.9. P1MODE: Port1 Digital/Analog Input Mode

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF2

Bits7–0: Port1 Digital/Analog Output Mode
0: Corresponding Port1 pin Digital Input disabled. (For analog use, i.e., ADC or comparators).
1: Corresponding Port1 pin Digital Input is enabled.

SFR Definition 14.10. P2: Port2 Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0	11111111
Bit7	Bit6	Bit	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xA0

Bits7–0: P2.[7:0]
(Write - Output appears on I/O pins per PRT0MX, PRT1MX, and PRT2MX registers)
0: Logic Low Output.
1: Logic High Output (high impedance if corresponding PRT2CF.n bit = 0)
(Read - Regardless of PRT0MX, PRT1MX, and PRT2MX Register settings).
0: P2.n is logic low.
1: P2.n is logic high.

SFR Definition 14.11. PRT2CF: Port2 Configuration Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xA6

Bits7–0: PRT2CF.[7:0]: Output Configuration Bits for P2.7–P2.0 (respectively)
0: Corresponding P2.n Output Mode is Open-Drain.
1: Corresponding P2.n Output Mode is Push-Pull.

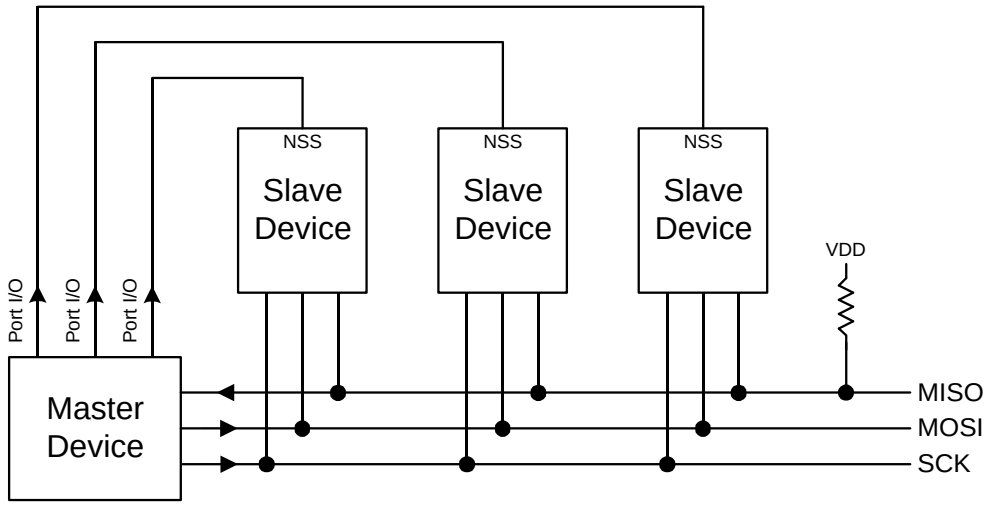


Figure 15.2. SPI Block Diagram

15.1. Signal Descriptions

The four signals used by the SPI (MOSI, MISO, SCK, NSS) are described below.

15.1.1. Master Out, Slave In

The master-out, slave-in (MOSI) signal is an output from a master device and an input to slave devices. It is used to serially transfer data from the master to the slave. Data is transferred most-significant bit first.

15.1.2. Master In, Slave Out

The master-in, slave-out (MISO) signal is an output from a slave device and an input to the master device. It is used to serially transfer data from the slave to the master. Data is transferred most-significant bit first. A SPI slave places the MISO pin in a high-impedance state when the slave is not selected.

15.1.3. Serial Clock

The serial clock (SCK) signal is an output from the master device and an input to slave devices. It is used to synchronize the transfer of data between the master and slave on the MOSI and MISO lines.

15.1.4. Slave Select

The slave select (NSS) signal is an input used to select the SPI module when in slave mode by a master, or to disable the SPI module when in master mode. When in slave mode, it is pulled low to initiate a data transfer and remains low for the duration of the transfer.

16. UART

Description

The CIP-51 includes a serial port (UART) capable of asynchronous transmission. The UART can function in full duplex mode. In all modes, receive data is buffered in a holding register. This allows the UART to start reception of a second incoming data byte before software has finished reading the previous data byte.

The UART has an associated Serial Control Register (SCON) and a Serial Data Buffer (SBUF) in the SFRs. The single SBUF location provides access to both transmit and receive registers. Reads access the Receive register and writes access the Transmit register automatically.

The UART is capable of generating interrupts if enabled. The UART has two sources of interrupts: a Transmit Interrupt flag, TI (SCON.1) set when transmission of a data byte is complete, and a Receive Interrupt flag, RI (SCON.0) set when reception of a data byte is complete. The UART interrupt flags are not cleared by hardware when the CPU vectors to the interrupt service routine. They must be cleared manually by software. This allows software to determine the cause of the UART interrupt (transmit complete or receive complete).

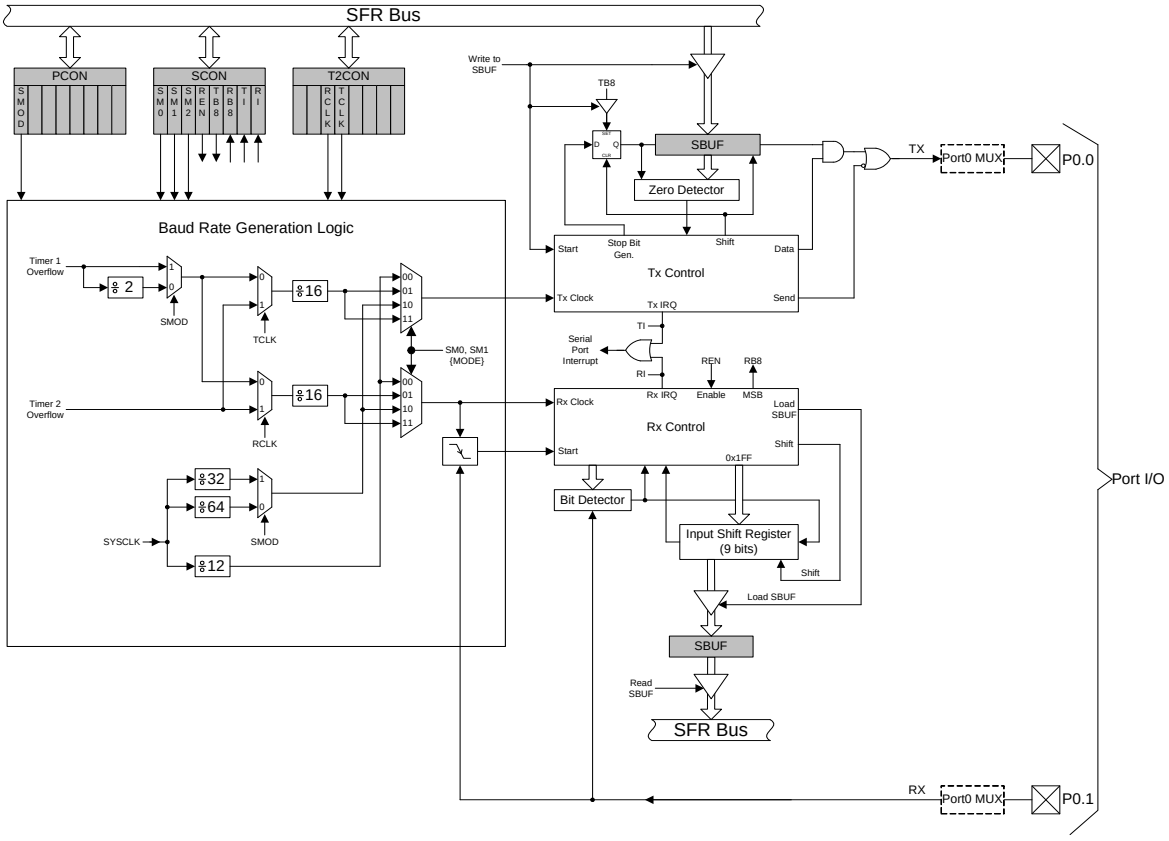


Figure 16.1. UART Block Diagram

16.1.3. Mode 2: 9-Bit UART, Fixed Baud Rate

Mode 2 provides asynchronous, full-duplex communication using a total of eleven bits per data byte: a start bit, 8 data bits (LSB first), a programmable ninth data bit, and a stop bit (see timing diagram in Figure 16.6). On transmit, the ninth data bit is determined by the value in TB8 (SCON.3). It can be assigned the value of the parity flag P in the PSW or used in multiprocessor communications. On receive, the ninth data bit goes into RB8 (SCON.2) and the stop bit is ignored.

Data transmission begins when an instruction writes a data byte to the SBUF register. The TI Transmit Interrupt Flag (SCON.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN Receive Enable bit (SCON.4) is set to logic 1. After the stop bit is received, the data byte will be loaded into the SBUF receive register if the following conditions are met: RI must be logic 0, and if SM2 is logic 1, the 9th bit must be logic 1.

If these conditions are met, the eight bits of data is stored in SBUF, the ninth bit is stored in RB8 and the RI flag is set. If these conditions are not met, SBUF and RB8 will not be loaded and the RI flag will not be set. An interrupt will occur if enabled when either TI or RI are set.

The baud rate in Mode 2 is a direct function of the system clock frequency as follows:

Mode 2 Baud Rate = 2SMOD x (SYSCLK / 64).

The SMOD bit (PCON.7) selects whether to divide SYSCLK by 32 or 64. In the formula, 2 is raised to the power SMOD, resulting in a baud rate of either 1/32 or 1/64 of the system clock frequency. On reset, the SMOD bit is logic 0, thus selecting the lower speed baud rate by default.

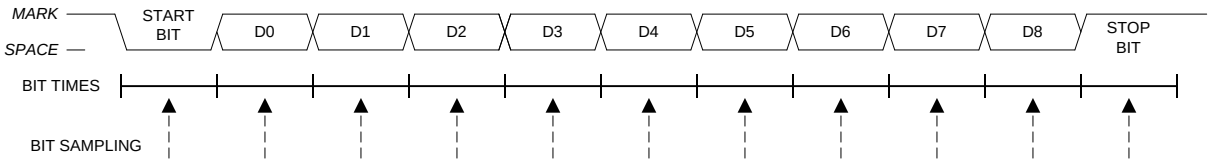


Figure 16.6. UART Modes 2 and 3 Timing Diagram

16.1.4. Mode 3: 9-Bit UART, Variable Baud Rate

Mode 3 is the same as Mode 2 in all respects except the baud rate is variable. The baud rate is determined in the same manner as for Mode 1. Mode 3 operation transmits 11 bits: a start bit, 8 data bits (LSB first), a programmable ninth data bit, and a stop bit. Timer 1 or Timer 2 overflows generate the baud rate just as with Mode 1. In summary, Mode 3 transmits using the same protocol as Mode 2 but with Mode 1 baud rate generation.

17.2. Timer 2

Timer 2 is a 16-bit counter/timer formed by the two 8-bit SFR's: TL2 (low byte) and TH2 (high byte). As with Timers 0 and 1, Timer 2 can use either the system clock or transitions on an external input pin as its clock source. The Counter/Timer Select bit C/T2 bit (T2CON.1) selects the clock source for Timer 2. Clearing C/T2 selects the system clock as the input for the timer (divided by either one or twelve as specified by the Timer Clock Select bit T2M in CKCON). When C/T2 is set to 1, high-to-low transitions at the T2 input pin increment the counter/timer register. (Refer to Section 14 for information on selecting and configuring external I/O pins.) Timer 2 can also be used to start an ADC Data Conversion (see section 5).

Timer 2 offers capabilities not found in Timer 0 and Timer 1. It operates in one of three modes: 16-bit Counter/Timer with Capture, 16-bit Counter/Timer with Auto-Reload or Baud Rate Generator Mode. Timer 2's operating mode is selected by setting configuration bits in the Timer 2 Control (T2CON) register. Below is a summary of the Timer 2 operating modes and the T2CON bits used to configure the counter/timer. Detailed descriptions of each mode follow.

RCLK	TCLK	CP/RL2	TR2	Mode
0	0	1	1	16-bit Counter/Timer with Capture
0	0	0	1	16-bit Counter/Timer with Auto-Reload
0	1	X	1	Baud Rate Generator for TX
1	0	X	1	Baud Rate Generator for RX
1	1	X	1	Baud Rate Generator for TX and RX
X	X	X	0	Off

18.1. Flash Programming Commands

The Flash memory can be programmed directly over the JTAG interface using the Flash Control, Flash Data, Flash Address, and Flash Scale registers. These Indirect Data Registers are accessed via the JTAG Instruction Register. Read and write operations on indirect data registers are performed by first setting the appropriate DR address in the IR register. Each read or write is then initiated by writing the appropriate Indirect Operation Code (IndOpCode) to the selected data register. Incoming commands to this register have the following format:

19:18	17:0
IndOpCode	**WriteData**

IndOpCode: These bit set the operation to perform according to the following table:

IndOpCode	Operation
0x	Poll
10	Read
11	Write

The Poll operation is used to check the Busy bit as described below. Although a Capture-DR is performed, no Update-DR is allowed for the Poll operation. Since updates are disabled, polling can be accomplished by shifting in/out a single bit.

The Read operation initiates a read from the register addressed by the DRAddress. Reads can be initiated by shifting only 2 bits into the indirect register. After the read operation is initiated, polling of the Busy bit must be performed to determine when the operation is complete.

The write operation initiates a write of WriteData to the register addressed by DRAddress. Registers of any width up to 18 bits can be written. If the register to be written contains fewer than 18 bits, the data in WriteData should be left-justified, i.e. its MSB should occupy bit 17 above. This allows shorter registers to be written in fewer JTAG clock cycles. For example, an 8-bit register could be written by shifting only 10 bits. After a Write is initiated, the Busy bit should be polled to determine when the next operation can be initiated. The contents of the Instruction Register should not be altered while either a read or write operation is in progress.

Outgoing data from the indirect Data Register has the following format:

19	18:5	0
0	**ReadData**	**Busy**

The Busy bit indicates that the current operation is not complete. It goes high when an operation is initiated and returns low when complete. Read and Write commands are ignored while Busy is high. In fact, if polling for Busy to be low will be followed by another read or write operation, JTAG writes of the next operation can be made while checking for Busy to be low. They will be ignored until Busy is read low, at which time the new operation will initiate. This bit is placed at bit 0 to allow polling by single-bit shifts. When waiting for a Read to complete and Busy is 0, the following 18 bits can be shifted out to obtain the resulting data. ReadData is always right-justified. This allows registers shorter than 18 bits to be read using a reduced number of shifts. For example, the result from a byte-read requires 9 bit shifts (Busy + 8 bits).

JTAG Register Definition 18.4. FLASHDAT: JTAG Flash Data

										Reset Value
DATA7	DATA6	DATA5	DATA4	DATA3	DATA2	DATA1	DATA0	FAIL	BUSY	0000000000
Bit9	Bit8	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

This register is used to read or write data to the Flash memory across the JTAG interface.

Bits9–2: DATA7–0: Flash Data Byte.
Bit1: FAIL: Flash Fail Bit.
- 0: Previous Flash memory operation was successful.
- 1: Previous Flash memory operation failed. Usually indicates the associated memory location was locked.

Bit0: BUSY: Flash Busy Bit.
- 0: Flash interface logic is not busy.
- 1: Flash interface logic is processing a request. Reads or writes while BUSY = 1 will not initiate another operation

JTAG Register Definition 18.5. FLASHSCL: JTAG Flash Scale

								Reset Value
FOSE	FRAE	-	-	FLSCL3	FLSCL2	FLSCL1	FLSCL0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	

This register controls the Flash read timing circuit and the prescaler required to generate the correct timing for Flash operations.

Bit7: FOSE: Flash One-Shot Enable Bit.
- 0: Flash read strobe is a full clock-cycle wide.
- 1: Flash read strobe is 50nsec.

Bit6: FRAE: Flash Read Always Bit.
- 0: The Flash output enable and sense amplifier enable are on only when needed to read the Flash memory.
- 1: The Flash output enable and sense amplifier enable are always on. This can be used to limit the variations in digital supply current due to switching the sense amplifiers, thereby reducing digitally induced noise.

Bits5–4: UNUSED. Read = 00b, Write = don't care.

Bits3–0: FLSCL3–0: Flash Prescaler Control Bits.
The FLSCL3–0 bits control the prescaler used to generate timing signals for Flash operations. Its value should be written before any Flash write or erase operations are initiated. The value written should be the smallest integer for which:

FLSCL[3:0] > log2(fSYSCLK / 50kHz)

Where fSYSCLK is the system clock frequency. All Flash read/write/erase operations are disallowed when FLSCL[3:0] = 1111b.